DEC 2.1 2005

Docket No. 5000-5118

UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s)

Tomohei SUGIYAMA et al.

Group Art Unit:

2891

Serial No

10/626,418

Examiner:

D. Menz

Filed

July 23, 2003

For

METHOD OF MANUFACTURING A LOW EXPANSION MATERIAL

AND SEMICONDUCTOR DEVICE USING THE LOW EXPANSION

MATERIAL

AMENDMENT AND RESPONSE TO OFFICE ACTION

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Responsive to the Official Action (non-final rejection) dated September 22, 2005, Applicants respectfully request reconsideration in view of the following amendments and remarks.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Amendments to Figure 9 are attached.

Remarks/Arguments begin on page 5 of this paper.